# onsemi

# Silicon Carbide (SiC) JFET – EliteSiC, Power N-Channel, TO247-3, 650 V, 25 mohm

# UJ3N065025K3S

# Description

**onsemi** offers the High-Performance G3 SiC normally-On JFET transistors. This Series Exhibits Ultra-low on resistance ( $R_{DS(ON)}$ ) and Gate charge ( $Q_G$ ) allowing for Low Conduction and Switching loss. The device Normally-On Characteristics with low  $R_{DS(ON)}$  at  $V_{GS} = 0$  V is also ideal for current protection circuits without the need for active control, as well as for cascode operation.

# Features

- Typical On-Resistance R<sub>DS(on), typ</sub> of 25 mΩ
- Voltage Controlled
- Maximum Operating Temperature of 175 °C
- Extremely Fast Switching not Dependent on Temperature
- Low Gate Charge
- Low Intrinsic Capacitance
- This Device is Pb-Free, Halogen Free and is RoHS Compliant

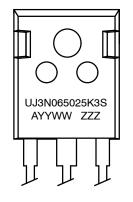
# **Typical Applications**

- Over Current Protection Circuits
- DC-AC Inverters
- Switch Mode Power Supplies
- Power Factor Correction Modules
- Motor Drives
- Induction Heating



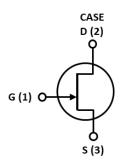
TO247-3 CASE 340AK

# MARKING DIAGRAM



| UJ3N065025K3S | = Specific Device Code |
|---------------|------------------------|
| А             | = Assembly Location    |
| YY            | = Year                 |
| WW            | = Work Week            |
| ZZZ           | = Lot ID               |
|               |                        |

#### **PIN CONNECTIONS**



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 7 of this data sheet.

### MAXIMUM RATINGS

| Parameter   | Symbol                            | Test Conditions         | Value      | Unit |
|---|-----------------------------------|-------------------------|------------|------|
| Drain-source Voltage  | V <sub>DS</sub>                   |                         | 650        | V    |
| Gate-Source Voltage   | V <sub>GS</sub>                   | DC                      | -20 to +3  | V    |
|   |                                   | AC (Note 1)             | -20 to +20 |      |
| Continuous Drain Current (Note 2)                                 | Ι <sub>D</sub>                    | T <sub>C</sub> = 25 °C  | 85         | Α    |
|   |                                   | T <sub>C</sub> = 100 °C | 62         | Α    |
| Pulsed Drain Current (Note 3)                                     | I <sub>DM</sub>                   | T <sub>C</sub> = 25 °C  | 250        | Α    |
| Power Dissipation   | P <sub>TOT</sub>                  | T <sub>C</sub> = 25 °C  | 441        | W    |
| Maximum Junction Temperature                                      | T <sub>J,max</sub>                |                         | 175        | °C   |
| Operating and Storage Temperature                                 | T <sub>J</sub> , T <sub>STG</sub> |                         | –55 to 175 | °C   |
| Max. Lead Temperature for Soldering, 1/8" from Case for 5 seconds | TL                                |                         | 250        | °C   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
1. +20 V AC Rating Applies for Turn-on Pulses <200 ns applied with external R<sub>G</sub> > 1 Ω
2. Limited by T<sub>J,max</sub>
3. Pulse width t<sub>p</sub> limited by T<sub>J,max</sub>

# THERMAL CHARACTERISTICS

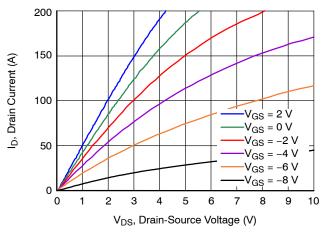
| Parameter                            | Symbol          | Test Conditions | Value |      |      |      |
|--------------------------------------|-----------------|-----------------|-------|------|------|------|
|                                      |                 |                 | Min   | Тур  | Max  | Unit |
| Thermal Resistance, Junction-to-Case | $R_{\theta JC}$ |                 | -     | 0.26 | 0.34 | °C/W |

# **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = +25 °C Unless otherwise specified)

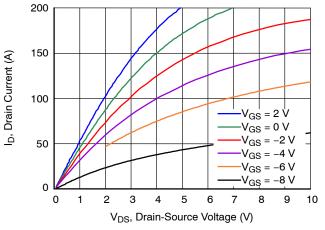
| Parameter                                    | Symbol               | Test Conditions  | Min | Тур   | Max   | Unit |
|--|----------------------|--|-----|-------|-------|------|
| TYPICAL PERFORMANCE - STATIC                 |                      |  |     |       |       |      |
| Drain-Source Breakdown Voltage               | BV <sub>DS</sub>     | $V_{GS} = -20 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$                       | 650 | -     | -     | V    |
| Total Drain Leakage Current                  | I <sub>D</sub>       | $V_{DS}$ = 650 V, $V_{GS}$ = -20 V,<br>T <sub>J</sub> = 25 °C                | -   | 10    | 60 μA |      |
|  |                      | V <sub>DS</sub> = 650 V, V <sub>GS</sub> = -20 V,<br>T <sub>J</sub> = 175 °C | -   | 40    | -     |      |
| Total Gate Leakage Current                   | l <sub>G</sub>       | V <sub>GS</sub> = -20 V, T <sub>J</sub> = 25 °C                              | -   | 10    | 100   | μA   |
|  |                      | V <sub>GS</sub> = -20 V, T <sub>J</sub> = 175 °C                             | -   | 38    | -     | μA   |
| Drain-Source On-Resistance                   | R <sub>DS(on)</sub>  | V <sub>GS</sub> = 2 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 25 °C         | -   | 22    | _     | mΩ   |
|  |                      | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 25 °C         | -   | 25    | 33    |      |
|  |                      | V <sub>GS</sub> = 2 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 175 °C        | -   | 38    | _     |      |
|  |                      | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 175 °C        | -   | 43    | _     |      |
| Gate Threshold Voltage                       | V <sub>G(th)</sub>   | V <sub>DS</sub> = 5 V, I <sub>D</sub> = 70 mA                                | -14 | -11.5 | -6    | V    |
| Gate Resistance                              | R <sub>G</sub>       | f = 1 MHz, Open Drain  | -   | 2.5   | _     | Ω    |
| TYPICAL PERFORMANCE – DYNAMIC                |                      |  | I   | I     |       |      |
| Input Capacitance                            | C <sub>iss</sub>     | $V_{DS} = 100 \text{ V}, V_{GS} = -20 \text{ V},$                            | -   | 2360  | _     | pF   |
| Output Capacitance                           | C <sub>oss</sub>     | f = 100 kHz  | _   | 290   | -     |      |
| Reverse Transfer Capacitance                 | C <sub>rss</sub>     |  | -   | 282   | -     |      |
| Effective Output Capacitance, Energy Related | C <sub>oss(er)</sub> | $V_{DS}$ = 0 V to 400 V, $V_{GS}$ = –20 V                                    | -   | 210   | -     | pF   |
| Total Gate Charge                            | Q <sub>G</sub>       | $V_{DS} = 400 \text{ V}, \text{ I}_{D} = 60 \text{ A},$                      | -   | 240   | -     | nC   |
| Gate-Drain Charge                            | Q <sub>GD</sub>      | $V_{GS} = -18 \text{ V to } 0 \text{ V}$                                     | -   | 134   | -     | 1    |
| Gate-Source Charge                           | Q <sub>GS</sub>      |  | -   | 24    | -     |      |
| Turn-On Delay Time                           | t <sub>d(on)</sub>   | $V_{DS} = 400 \text{ V}, \text{ I}_{D} = 60 \text{ A},$                      | -   | 11    | -     | ns   |
| Rise Time                                    | t <sub>r</sub>       | Gate Driver = $-18$ V to +0 V,<br>R <sub>G. EXT</sub> = 1 $\Omega$ ,         | -   | 64    | -     |      |
| Turn-Off Delay Time                          | t <sub>d(off)</sub>  | Inductive Load,  | -   | 43    | -     |      |
| Fall Time                                    | t <sub>f</sub>       | FWD: UJ3D06530TS T <sub>J</sub> = 25 °C                                      | -   | 44    | -     |      |
| Turn-On Energy                               | E <sub>ON</sub>      |  | -   | 740   | -     | μJ   |
| Turn-Off Energy                              | E <sub>OFF</sub>     |  | -   | 818   | -     |      |
| Total Switching Energy                       | E <sub>TOTAL</sub>   |  | -   | 1558  | -     |      |
| Turn-On Delay Time                           | t <sub>d(on)</sub>   | $V_{DS} = 400 \text{ V}, \text{ I}_{D} = 60 \text{ A},$                      | -   | 11    | -     | ns   |
| Rise Time                                    | tr                   | Gate Driver = $-18$ V to +0 V,<br>R <sub>G EXT</sub> = 1 $\Omega$ ,          | -   | 62    | -     | 1    |
| Turn-Off Delay Time                          | t <sub>d(off)</sub>  | Inductive Load,  | -   | 38    | _     | 1    |
| Fall Time                                    | t <sub>f</sub>       | FWD: UJ3D06530TS T <sub>J</sub> = 150 °C                                     | -   | 41    | -     | 1    |
| Turn-On Energy                               | E <sub>ON</sub>      | 1  | _   | 663   | -     | μJ   |
| Turn-Off Energy                              | E <sub>OFF</sub>     | 1  | _   | 750   | -     | 1    |
| Total Switching Energy                       | E <sub>TOTAL</sub>   | 1  | _   | 1413  | -     | 1    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **TYPICAL PERFORMANCE DIAGRAMS**









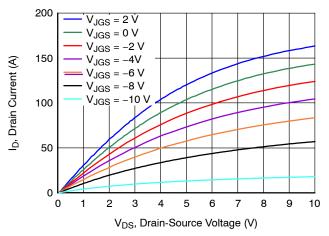
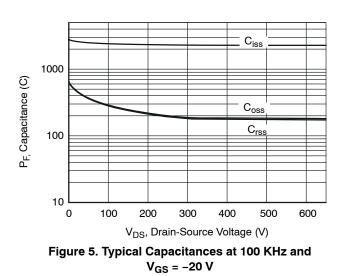


Figure 3. Typical Output Characteristics at T<sub>J</sub> = 175 °C



1.E-03 T<sub>.1</sub> = 175 °Ċ Drain Leakage Current (A) T<sub>J</sub> = 125 °C T<sub>J</sub> = 25 °C 1.E-04 T.I = -55 °C 1.E-05 1.E-06 ò 1.E-07 100 200 300 400 500 600 V<sub>DS</sub>, Drain-Source Voltage (V)

Figure 4. Typical Drain–Source Leakage at V<sub>DS</sub> = -20 V

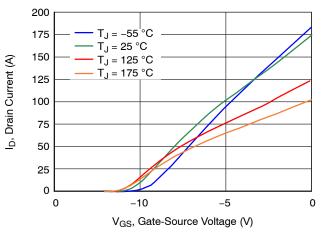
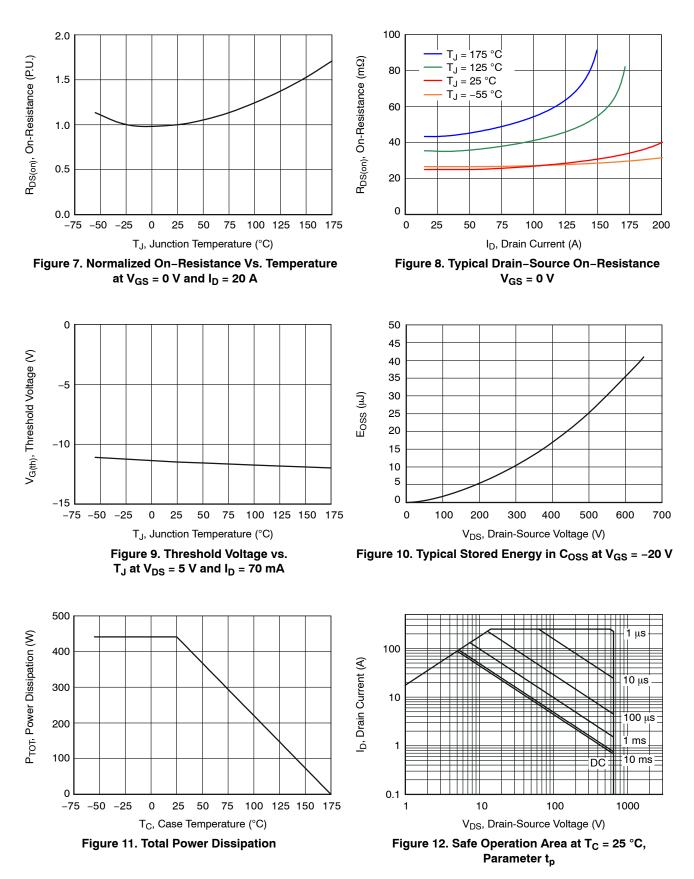
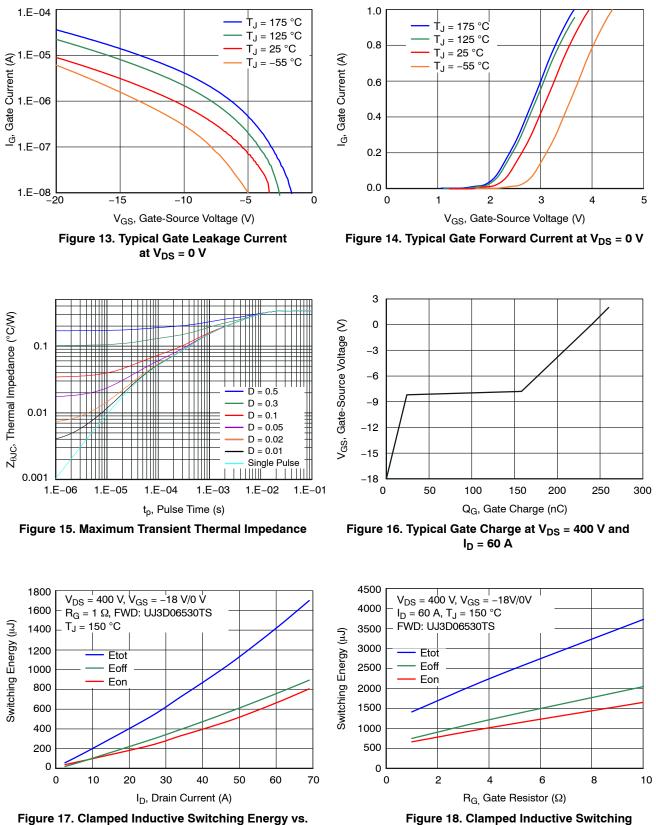


Figure 6. Typical Transfer Characteristics at  $V_{DS}$  = 5 V

### TYPICAL PERFORMANCE DIAGRAMS (CONTINUED)



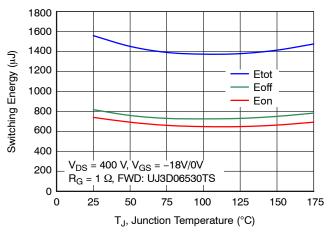
#### TYPICAL PERFORMANCE DIAGRAMS (CONTINUED)

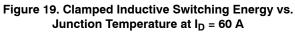


Energy vs. Gate Resistor R<sub>G</sub>

Drain Current at T<sub>J</sub> = 150 °C

# TYPICAL PERFORMANCE DIAGRAMS (CONTINUED)



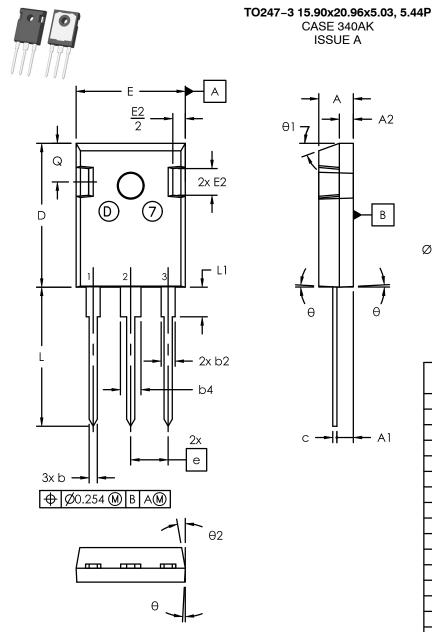


#### **ORDERING INFORMATION**

| Part Number   | Marking       | Package                            | Shipping         |
|---------------|---------------|------------------------------------|------------------|
| UJ3N065025K3S | UJ3N065025K3S | TO247-3<br>(Pb–Free, Halogen Free) | 600 Units / Tube |

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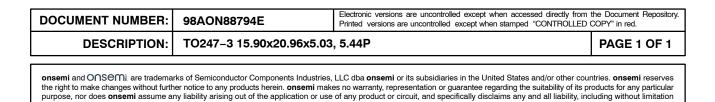
**∲**Ø0.635 **∭** B A **∭** 



NOTE:

- 1. Dimensioning and tolerancing as per ASME Y14.5 2018
- 2. Controlling dimension : millimeters
- 3. Package Outline in compliance with JEDEC standard var. AD.
- 4. Dimensions D & E does not include mold flash.
- 5. ØP to have max draft angle of 1.7° to the top with max. hole diameter of 3.91mm.

special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.



DATE 12 FEB 2025

| 5VNA | 1    | millimeters | 5                    |
|------|------|-------------|----------------------|
| SYM  | MIN  | NOM         | MAX                  |
| А    | 4.70 | 5.03        | 5.3                  |
| A1   | 2.21 | 2.40        | 2.59                 |
| A2   | 1.50 | 2.03        | 2.59<br>2.49<br>1.40 |
| b    | 0.99 | 1.20        | 1.40                 |
| b2   | 1.65 | 2.03        | 2.39                 |
| b4   | 2.59 | 3.00        | 3.43                 |
| -    | 0.00 | <u> </u>    |                      |

| b2  | 1.65     | 2.03     | 2.39  |  |
|-----|----------|----------|-------|--|
| b4  | 2.59     | 3.00     | 3.43  |  |
| С   | 0.38     | 0.60     | 0.89  |  |
| D   | 20.70    | 20.96    | 21.46 |  |
| D1  | 13.08    | -        | -     |  |
| D2  | 0.51     | 1.19     | 1.35  |  |
| E   | 15.49    | 15.90    | 16.26 |  |
| е   |          | 5.44 BSC |       |  |
| E1  | 13.00    | 14.02    | 13.60 |  |
| E2  | 3.43     | 3.89     | 5.20  |  |
| L   | 19.62    | 20.27    | 20.32 |  |
| L1  | -        | -        | 4.50  |  |
| ØP  | 3.40     | 3.60     | 3.80  |  |
| ØP1 | 7.06     | 7.19     | 7.39  |  |
| Q   | 5.38     | 5.62     | 6.20  |  |
| S   | 6.15 BSC |          |       |  |
| θ   | 3°       |          |       |  |
| θ1  | 20°      |          |       |  |
| θ2  | 10°      |          |       |  |

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